

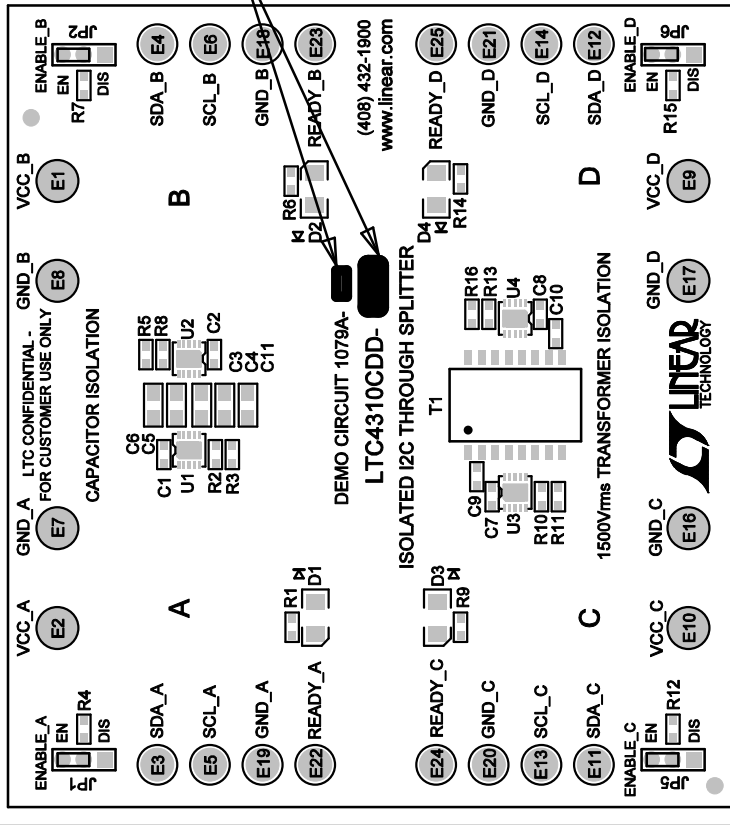
REVISION HISTORY				
ECO	REV	DESCRIPTION	APPROVAL	DATE
	3	THIRD PROTOTYPE	D. REYES	06/28/10

NOTES: UNLESS OTHERWISE SPECIFIED,

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.

7 MARK APPROPRIATE ASSEMBLY APPROXIMATELY WHERE SHOWN.

ASSY	U1-U4	R2, R3, R5, R8, R10, R11, R13, R16
-A	LTC4310CDD-1	10k
-B	LTC4310CDD-2	3.3K



APPROVALS		LTC TECHNOLOGY	
PCB DES.	MI	1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.linear.com LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY	
APP. ENG.	DILLIAN R.	TITLE: TOP ASSEMBLY DRAWING, ISOLATED I2C THROUGH SPLITTER	
		SIZE	IC NO
		N/A	LTC4310CDD
		REV	3
SCALE: NONE		FILENAME: 1079A-3.PCB	
		SHT 1 of 1	